

#### DESCRIPTION

The PS2505-1, PS2505-2 and PS2505-4 series of optocouplers consist of two infrared light emitting diodes connected in reverse parallel optically coupled to an NPN silicon photo transistor in a space efficient Dual In Line Plastic Package.

#### **FEATURES**

- AC Isolation Voltage 5000V<sub>RMS</sub>
- Wide Operating Temperature Range PS2505-1: -50°C to +110°C PS2505-2 / PS2505-4 : -30°C to +100°C
- **RoHS Compliant**
- UL File E91231 Model "EE"
- VDE Approval Certificate No. 40028086

#### **APPLICATIONS**

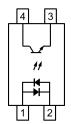
- **Computer Terminals**
- **Industrial System Controllers**
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

#### ORDER INFORMATION

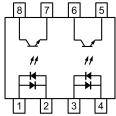
- Add X after PN for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount version
- Add SMT&R after PN for Surface Mount Tape & Reel version available for PS2505-1SM PS2505-2SM
- Consult Factory for Tape and Reel version of PS2505-4SM



#### PS2505-1

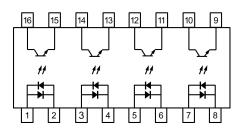


PS2505-2



- 1 Anode/Cathode
- 2 Cathode/Anode
- 3 Emitter
- 4 Collector
- 1, 3 Anode/Cathode
- 2, 4 Cathode/Anode
- 5, 7 Emitter
- 6, 8 Collector

#### PS2505-4



1, 3, 5, 7 Anode/Cathode 2, 4, 6, 8 Cathode/Anode

9, 11, 13, 15 Emitter 10, 12, 14, 16 Collector

#### **ISOCOM COMPONENTS 2004 LTD**

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#### ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

#### Input

**Forward Current** ±50mA Power dissipation 70mW

#### Output

Collector to Emitter Voltage BV<sub>CEO</sub> 80V Emitter to Collector Voltage BV<sub>ECO</sub> 6V 50mA Collector Current **Power Dissipation** 150mW

#### **Total Package**

Isolation Voltage  $5000V_{RMS}$ **Total Power Dissipation** 200mW

Operating Temperature

PS2505-1 -50 to 110°C

PS2505-2 / PS2805-4 -30 to 100°C

Storage Temperature -55 to 125°C

Junction Temperature 125°C Lead Soldering Temperature (10s) 260°C

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#### **ELECTRICAL CHARACTERISTICS** (Ambient Temperature = 25°C unless otherwise specified)

#### **INPUT**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	$V_{F}$	$I_F = \pm 20 \text{mA}$		1.2	1.4	V
Terminal Capacitance	$C_{t}$	V = 0V, $f = 1KHz$		30	250	pF

#### **OUTPUT**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector—Emitter breakdown Voltage	$BV_{CEO}$	$I_C = 0.1 \text{mA}, I_F = 0 \text{mA}$	80			V
Emitter—Collector breakdown Voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_E=10\mu A,I_F=0mA$	6			V
Collector-Emitter Dark Current	$I_{CEO}$	$V_{CE} = 20V$ , $I_F = 0mA$			100	nA

#### **COUPLED**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current Transfer Ratio	CTR	$I_F = \pm 5 \text{mA}, \ V_{CE} = 5 \text{V}$	80		600	%
Collector—Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_F = \pm 20 \text{mA}, I_C = 1 \text{mA}$		0.1	0.2	V
Floating Capacitance	$\mathrm{C_{f}}$	V = 0V, $f = 1MHz$		0.6	1	pF
Output Rise Time	$t_{\rm r}$	$V_{CE} = 2V$ $I_{C} = 2mA$		4	18	μs
Output Fall Time	$t_{\mathrm{f}}$	$R_L = 100\Omega$		3	18	

#### **ISOLATION**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Input to Output Isolation Voltage	$ m V_{ISO}$	R.H. = 40% to 60% t = 1 min	5000			$V_{RMS}$
Input to Output Isolation Resistance	$R_{\rm ISO}$	$V_{IO} = 500 VDC$ R.H. = 40% to 60%	5 x 10 <sup>10</sup>	1 x 10 <sup>11</sup>		Ω

Device is considered a two terminal device: Input pins are shorted together and Output pins are shorted together.



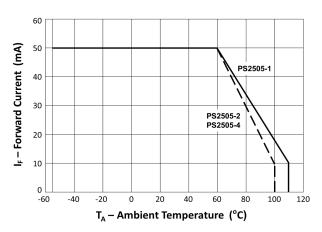


Fig 1 Forward Current vs Ambient Temperature

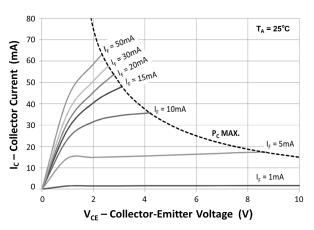


Fig 3 Collector Current vs Collector-Emitter Voltage (1)

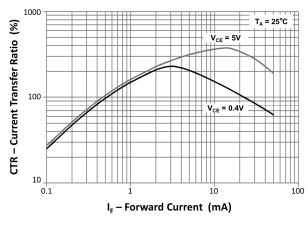


Fig 5 Current Transfer Ratio vs Forward Current

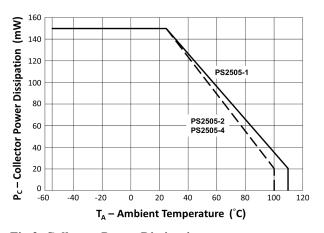


Fig 2 Collector Power Dissipation vs Ambient Temperature

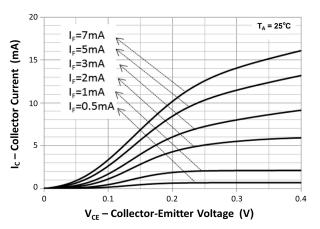


Fig 4 Collector Current vs Collector-Emitter Voltage (2)

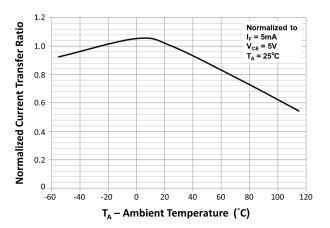


Fig 6 Normalized Current Transfer Ratio vs Ambient Temperature



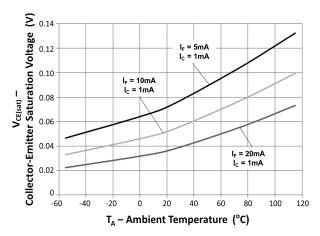


Fig 7 Collector-Emitter Saturation Voltage vs Ambient Temperature

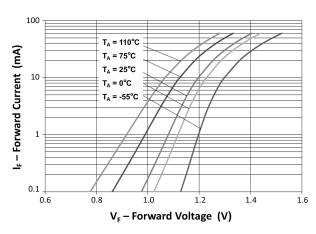


Fig 9 Forward Current vs Forward Voltage

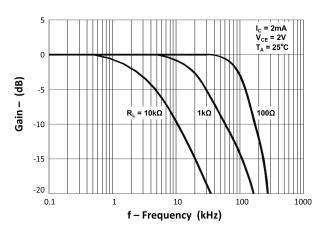


Fig 11 Frequency Response

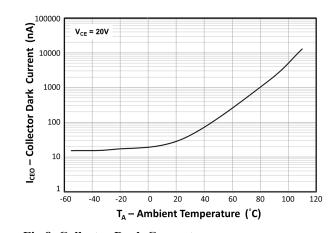


Fig 8 Collector Dark Current vs Ambient Temperature

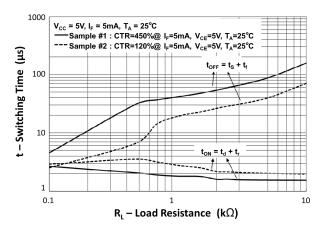
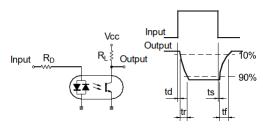
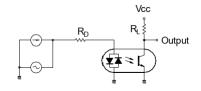


Fig 10 Switching Time vs Load Resistance



**Response Time Test Circuit** 



**Frequency Response Test Circuit** 



#### **ORDER INFORMATION**

PS2505-1 (UL Approval)				
After PN	PN	Description	Packing quantity	
None	PS2505-1	Standard DIP4	100 pcs per tube	
G	PS2505-1G	10mm Lead Spacing	100 pcs per tube	
SM	PS2505-1SM	Surface Mount	100 pcs per tube	
SMT&R	PS2505-1SMT&R	Surface Mount Tape & Reel	1000 pcs per reel	

	PS2505-2 (UL Approval)				
After PN	PN	Description	Packing quantity		
None	PS2505-2	Standard DIP8	50 pcs per tube		
G	PS2505-2G	10mm Lead Spacing	50 pcs per tube		
SM	PS2505-2SM	Surface Mount	50 pcs per tube		
SMT&R	PS2505-2SMT&R	Surface Mount Tape & Reel	1000 pcs per reel		

	PS2505-4 (UL Approval)				
After PN	PN	Description	Packing quantity		
None	PS2505-4	Standard DIP16	25 pcs per tube		
G	PS2505-4G	10mm Lead Spacing	25 pcs per tube		
SM	PS2505-4SM	Surface Mount	25 pcs per tube		

Consult Factory for Tape and Reel version of PS2505-4SM



#### **ORDER INFORMATION**

	PS2505-1 (UL and VDE Approvals)				
After PN	PN	Description	Packing quantity		
None	PS2505-1X	Standard DIP4	100 pcs per tube		
G	PS2505-1XG	10mm Lead Spacing	100 pcs per tube		
SM	PS2505-1XSM	Surface Mount	100 pcs per tube		
SMT&R	PS2505-1XSMT&R	Surface Mount Tape & Reel	1000 pcs per reel		

	PS2505-2 (UL and VDE Approvals)				
After PN	PN	Description	Packing quantity		
None	PS2505-2X	Standard DIP8	50 pcs per tube		
G	PS2505-2XG	10mm Lead Spacing	50 pcs per tube		
SM	PS2505-2XSM	Surface Mount	50 pcs per tube		
SMT&R	PS2505-2XSMT&R	Surface Mount Tape & Reel	1000 pcs per reel		

	PS2505-4 (UL and VDE Approvals)				
After PN	PN	Description	Packing quantity		
None	PS2505-4X	Standard DIP16	25 pcs per tube		
G	PS2505-4XG	10mm Lead Spacing	25 pcs per tube		
SM	PS2505-4XSM	Surface Mount	25 pcs per tube		

Consult Factory for Tape and Reel version of PS2505-4XSM



#### **DEVICE MARKING**

PS2505-xX /YYWW EE



PS2505-x Device Part Number where "x" denotes number of Channels

1 : Single Channel2 : Dual Channel4 : Quad Channel

X VDE Option

I Isocom

YY 2 digit Year code (22, 23, etc.)

WW 2 digit Week code

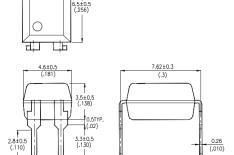
EE UL Model



#### **PACKAGE DIMENSIONS in mm (inch)**

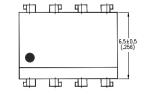
DIP

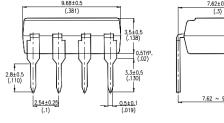




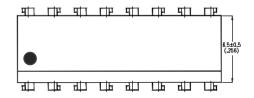
97 FP

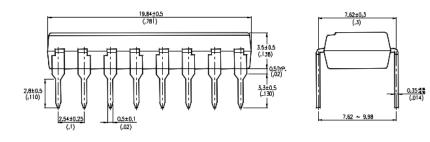
#### PS2505-2





#### PS2505-4



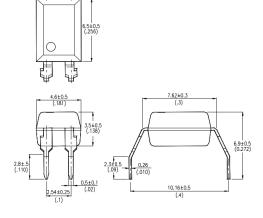




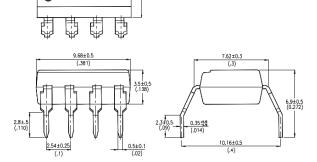
### **PACKAGE DIMENSIONS in mm (inch)**

#### **G** Form

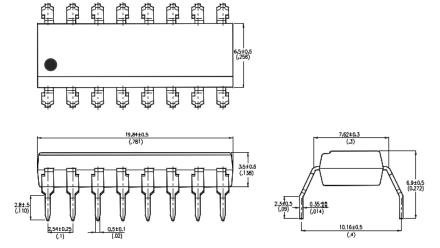
PS2505-1G



#### PS2505-2G



#### PS2505-4G

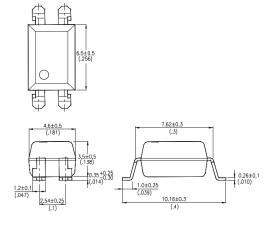




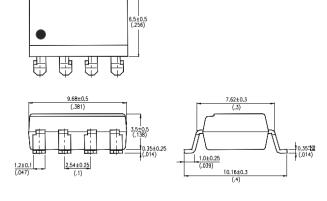
## **PACKAGE DIMENSIONS in mm (inch)**

#### **SMD**

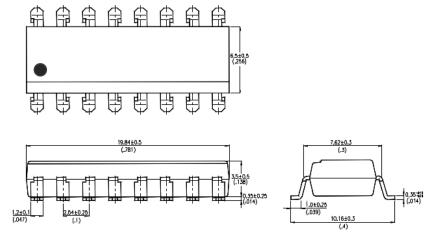
#### PS2505-1SM



#### PS2505-2SM



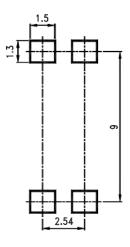
#### PS2505-4SM



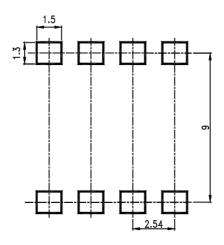


## RECOMMENDED PAD LAYOUT FOR SMD (mm)

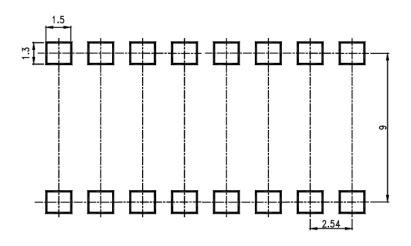
#### PS2505-1SM



#### PS2505-2SM



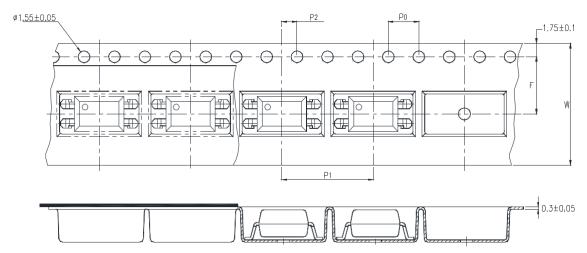
#### PS2505-4SM





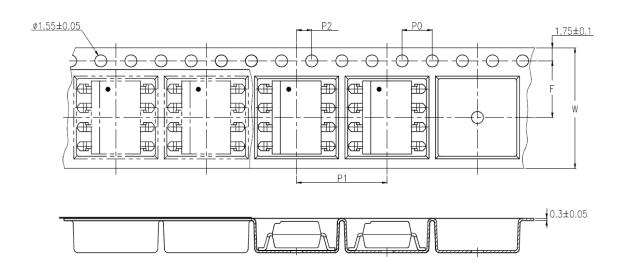
#### **TAPE AND REEL PACKAGING**

#### **PS2505-1SMT&R**



#### -2SMT&R

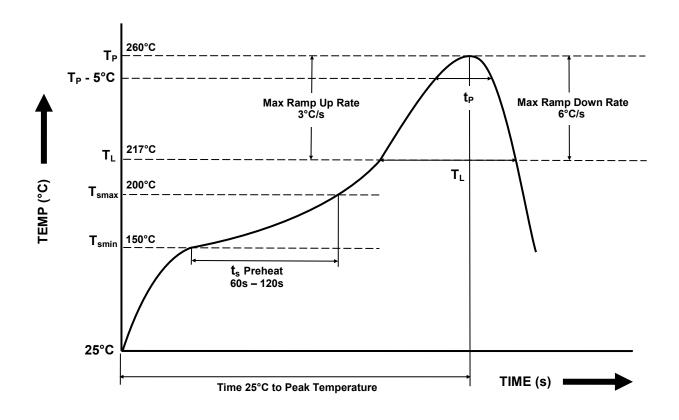




Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P <sub>0</sub>	4 ± 0.1 (0.15)
Distance of Compartment to Spreaket Heles	F	7.5 ± 0.1 (0.295)
Distance of Compartment to Sprocket Holes	P <sub>2</sub>	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P <sub>1</sub>	12 ± 0.1 (0.472)



# IR REFLOW SOLDERING TEMPERATURE PROFILE FOR SMD (One Time Reflow Soldering is Recommended)



Profile Details	Conditions
$ \begin{array}{l} \textbf{Preheat} \\ \textbf{- Min Temperature } (T_{SMIN}) \\ \textbf{- Max Temperature } (T_{SMAX}) \\ \textbf{- Time T}_{SMIN} \ \text{to T}_{SMAX} \left( t_{s} \right) \end{array} $	150°C 200°C 60s - 120s
$\begin{tabular}{lll} \textbf{Soldering Zone} \\ &- \mbox{Peak Temperature } (T_P) \\ &- \mbox{Time at Peak Temperature} \\ &- \mbox{Liquidous Temperature } (T_L) \\ &- \mbox{Time within } 5^{\circ}\mbox{C of Actual Peak Temperature } (T_P - 5^{\circ}\mbox{C}) \\ &- \mbox{Time maintained above } T_L  (t_L) \\ &- \mbox{Ramp Up Rate } (T_L \mbox{ to } T_P) \\ &- \mbox{Ramp Down Rate } (T_P \mbox{ to } T_L) \\ \end{tabular}$	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T <sub>smax</sub> to T <sub>P</sub> )	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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